THAT WHICH IS CLAIMED IS:

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1. An integrated circuit capacitor, comprising:

an electrically insulating electrode support layer having an opening therein, on an integrated circuit substrate;

a U-shaped lower electrode in the opening;

a first capacitor dielectric layer extending on an inner surface and outer portion of the U-shaped lower electrode;

a second capacitor dielectric layer extending between the outer portion of the U-shaped lower electrode and the first capacitor dielectric and also extending between the outer portion of the U-shaped lower electrode and an inner sidewall of the opening; and

an upper electrode on the first capacitor dielectric layer.

- 2. The integrated circuit capacitor of Claim 1, wherein the second capacitor dielectric layer does not extend on the inner surface of the U-shaped lower electrode.
- 3. The integrated circuit capacitor of Claim 1, wherein the electrically insulating electrode support layer comprises:
 a mold layer on the integrated circuit substrate; and
 an etch stop layer on the mold layer.
- 4. The integrated circuit capacitor of Claim 3, wherein the mold layer comprises silicon oxide and wherein the etch stop layer comprises at least one of silicon nitride and/or tantalum oxide.
- 5. The integrated circuit capacitor of Claim 1, wherein the first capacitor dielectric layer extends onto the support layer.
- The integrated circuit capacitor of Claim 1, wherein the first
 capacitor dielectric layer comprises tantalum oxide, aluminum oxide (Al₂O₃), and/or
 Hafnium Oxide (HfO₂).

- 7. The integrated circuit capacitor of Claim 1, wherein the second capacitor dielectric layer comprises a dielectric material that is not etched by an oxide etchant.
- 8. An integrated circuit capacitor, comprising:

an electrically insulating electrode support layer having an opening therein, on an integrated circuit substrate;

- a U-shaped lower electrode in the opening;
- a first capacitor dielectric layer extending on an inner surface and outer portion of the U-shaped lower electrode; and
 - a second capacitor dielectric layer extending between the outer portion of the U-shaped lower electrode and the first capacitor dielectric and also extending between the outer portion of the U-shaped lower electrode and an inner sidewall of the opening.

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9. An integrated circuit capacitor, comprising:

an electrically insulating electrode support layer having an opening therein, on an integrated circuit substrate;

a U-shaped lower electrode in the opening, the U-shaped lower electrode having an inner surface and outer portion; and

a capacitor dielectric layer extending on the outer portion of the U-shaped lower electrode and also extending between the outer portion of the U-shaped lower electrode and an inner sidewall of the opening.